

#### Express recovery Rectifier diode Reverse Voltage600v Forward current-3A

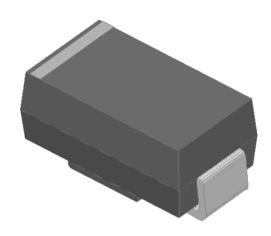
#### Features

Glass passivated chip High surge current capability Ldeal for surface mounted applications Low power loss, high efficiency Plastic Case Material has UL Flammability

#### Mechanical Data

Package: SMB Terminals:Tin Plated leads, solderable per Mil-STD-750 Method 2026 Polarity: As marked Molding compound meets UL 94 V-0 flammability rating, ROHS-compliant

#### Maximum Ratings (Ta=25°C Unless otherwise

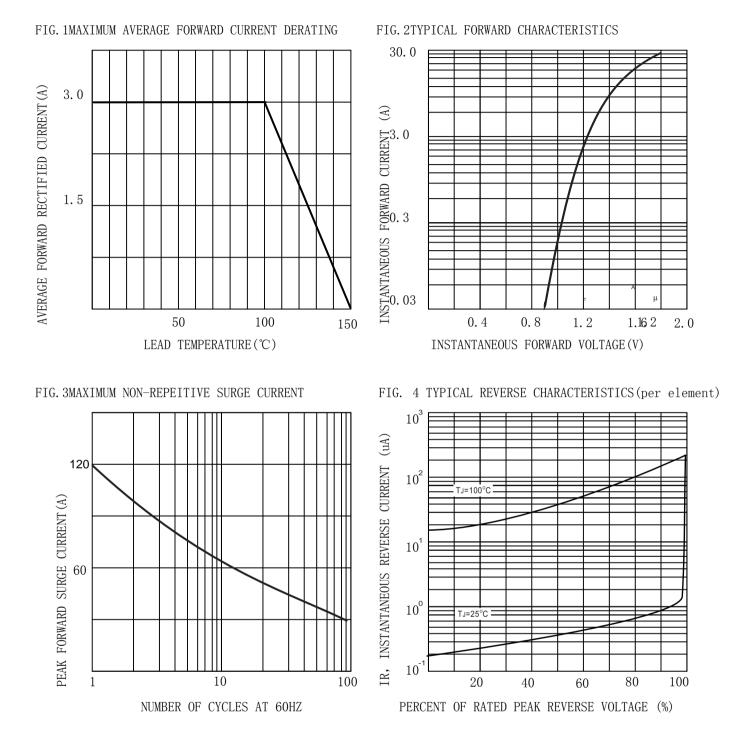




Type Number	SYMBOL	ES3JBH	Umit	
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	600	V	
Maximum RMS Voltage	V <sub>RMS</sub>	420	V	
Maximum DC Blocking Voltage	V <sub>DC</sub>	600	V	
Maximum Average Forward Rectified Current at TL = 100 $^\circ\!\!\mathbb{C}$	IO <sub>(AV)</sub> 3.0		А	
Peak Forward Surge Current 8.3ms Single half-sine-wave superimposed on rated load(JEDEC Method) on rated	IFSM	120.0	A	
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C		240.0	A	
Current squared time @1ms≤t8.3≤ms Tj=25℃,Rating of per diode	l <sup>2</sup> t	59.8	A <sup>2</sup> S	
Maximum Forward Voltage at 3.0A DC	V <sub>FM</sub>	1.3	V	
Maximum Reverse Current TA = 25℃		5.0	uA	
at Rated DC Blocking Voltage TA = 100 $^{\circ}$ C	IR –	100.0		
Maximum reverse recovery time	Trr	35.0	ns	
Typical Thermal Resistance Between junction and	$R_{QJa}$	50.0	°C/W	
Operating Junction Temperature Range	TJ		°C	
Storage Temperature Range	T <sub>STG</sub>		°C	



# ES3JBH





### **MARKING INFORMATION**

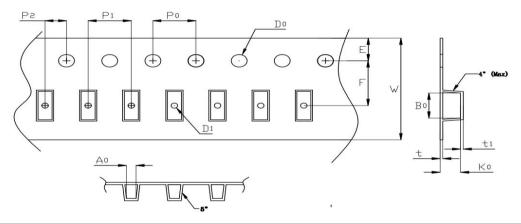


ES3JBH. = Marking Code

Print according to customer request

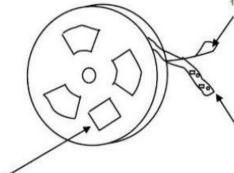
### **PACKING REQUIRMENTS**

Carrier tape packing



Ī	Specificati	Carrier	40	Во	Ko	Ро	W	+	Exiplain
	ons	tape type	Ao	ВО	Ко	FU	vv	L	Lxipiairi
	SMB	Anti-static	3.8± 0.10	5.4± 0.10	2.45± 0.10	$4.00 \pm 0.10$	$12.0 \pm 0.10$	0.23± 0.05	

覆盖胶带(COVER TAPE)



装件袋 (CARRIER TAPE )

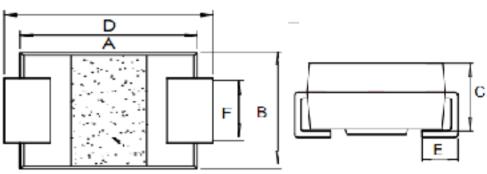
标签黏着面(仅一面)

Ī	DEVICE TYPE	Tape width	13"Reel			
			Q'TY/REEL (pcs)	BOX/CAR TOON	Q'TY/REEL (pcs)	
	SMB	12mm	3000	20	60000	



## Outline Dimensions

### SMB



SMB					
DTM	INC	HES	ММ		
DIM	MIN	MAX	MIN	MAX	
А	0.16	0.19	4	4.8	
В	0.13	0.15	3.3	3.9	
С	0.08	0.10	2	2.5	
D	0.18	0.22	4.5	5.5	
E	0.03	0.06	0.7	1.5	
F	0.06	0.10	1.5	2.5	



### Important Statements and disclaimers.

Do not copy or modify file information without permission.

Xumao Micro reserves the right to modify this document and its products.

Specifications are available without prior notice. Customer shall obtain and confirm the latest product information and specifications prior to final design, purchase or use.

Xumao Micro does not assume any implied warranties, including warranties of fitness for special purposes, non-infringement and merchantability.

The products shown here are not designed and licensed for demanding equipment at a level of reliability or for human life and any life-saving related applications or life-sustaining, such as medical devices, transportation equipment, aerospace machinery, and so on. Customers who use or sell these products for such applications do so at their own risk.

As Xumao Micro uses batch number as tracking benchmark, please provide batch number for tracking in case of exception.